Low switching losses
Low reverse recovery charge
Distributed amplified gate for high di_T/dt

Fast Thyristor
Type TFI373-1600-28

Mean on-state current			I_{TAV}	1600 A	
Repetitive peak off-state voltage			V_{DRM}	2000 ÷ 2800 V	
Repetitive peak reverse voltage			V_{RRM}		
Turn-off time			t_q	50.0, 63.0 µs	
V_{DRM}, V_{RRM}, V	2000	2200	2400	2600	2800
Voltage code	20	22	24	26	28
T_j, °C	– 60 ÷ 125				

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Mean on-state current	A	1600 2610	T_c=90 °C; Double side cooled; T_c=55 °C; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	2510	T_c=90 °C; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	34.5 40.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=10 ms; single pulse; V_D=V_R=0 V; Gate pulse:I_G=I_{FGM}; V_G=20 V; t_{GP}=50 µs; di_G/dt=2 A/µs
			36.0 41.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=8.3 ms; single pulse; V_D=V_R=0 V; Gate pulse:I_G=I_{FGM}; V_G=20 V; t_{GP}=50 µs; di_G/dt=2 A/µs
I^2t	Safety factor	$A^2s\cdot10^3$	5900 8000	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=10 ms; single pulse; V_D=V_R=0 V; Gate pulse:I_G=I_{FGM}; V_G=20 V; t_{GP}=50 µs; di_G/dt=2 A/µs
			5300 6900	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=8.3 ms; single pulse; V_D=V_R=0 V; Gate pulse:I_G=I_{FGM}; V_G=20 V; t_{GP}=50 µs; di_G/dt=2 A/µs
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	2000÷2800	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	2100÷2900	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	0.6·V_{DRM} 0.6·V_{RRM}	T_j=$T_{j\,max}$; Gate open	

TRIGGERING				
I_{FGM}	Peak forward gate current	A	10	$T_j=T_{j\,max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	8	$T_j=T_{j\,max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/µs	2500	$T_j=T_{j\,max}$; $V_D=0.67 \cdot V_{DRM}$; $I_{TM}=2\ I_{TAV}$; Gate pulse: $I_G=2$ A; $V_G=20$ V; $t_{GP}=50$ µs; $di_G/dt=2$ A/µs
THERMAL				
T_{stg}	Storage temperature	°C	-60 ÷ 50	
T_j	Operating junction temperature	°C	-60 ÷ 125	
MECHANICAL				
F	Mounting force	kN	40.0 ÷ 50.0	
a	Acceleration	m/s^2	50	Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	2.26	$T_j=25$ °C; $I_{TM}=5024$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.40	$T_j=T_{j\,max}$; $0.5\ \pi\ I_{TAV} < I_T < 1.5\ \pi\ I_{TAV}$	
r_T	On-state slope resistance, max	mΩ	0.200		
I_H	Holding current, max	mA	1000	$T_j=25$ °C; $V_D=12$ V; Gate open	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j=T_{j\,max}$; $V_D=V_{DRM}$; $V_R=V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage[1], min	V/µs	200, 320, 500, 1000	$T_j=T_{j\,max}$; $V_D=0.67 \cdot V_{DRM}$; Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	5.00 3.00 2.00	$T_j=T_{j\,min}$ $T_j=25$ °C $T_j=T_{j\,max}$	$V_D=12$ V; $I_D=3$ A; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	500 300 200	$T_j=T_{j\,min}$ $T_j=25$ °C $T_j=T_{j\,max}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j=T_{j\,max}$; $V_D=0.67 \cdot V_{DRM}$; Direct gate current	
I_{GD}	Gate non-trigger direct current, min	mA	15.00		
SWITCHING					
t_{gd}	Delay time, max	µs	1.06	$T_j=25$ °C; $V_D=1500$ V; $I_{TM}=I_{TAV}$; $di/dt=200$ A/µs; Gate pulse: $I_G=2$ A; $V_G=20$ V; $t_{GP}=50$ µs; $di_G/dt=2$ A/µs	
t_{gt}	Turn-on time[2]	µs	2.50, 3.20, 4.00, 6.30		
t_q	Turn-off time[3], max	µs	50.0, 63.0	$dv_D/dt=50$ V/µs;	$T_j=T_{j\,max}$; $I_{TM}=I_{TAV}$; $di_R/dt=-10$ A/µs; $V_R=100$V; $V_D=0.67\ V_{DRM}$
			63.0, 80.0	$dv_D/dt=200$ V/µs;	
Q_{rr}	Total recovered charge(linear), max	µC	1250	$T_j=T_{j\,max}$; $I_{TM}=2000$ A; $di_R/dt=-50$ A/µs; $V_R=100$ V	
t_{rr}	Reverse recovery time, max	µs	9.0		
I_{rrM}	Peak reverse recovery current, max	A	280		

THERMAL					
R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.0100	Direct current	Double side cooled
R_{thjc-A}			0.0220		Anode side cooled
R_{thjc-K}			0.0180		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	°C/W	0.0020	Direct current	
MECHANICAL					
w	Weight, typ	g	1600		
D_s	Surface creepage distance	mm (inch)	55.13 (2.170)		
D_a	Air strike distance	mm (inch)	25.10 (0.988)		

PART NUMBERING GUIDE

TFI	373	1600	28	A2	E3	M4	N
1	2	3	4	5	6	7	8

1. TFI — Fast Thyristor
   TFIS — Fast Thyristor with Distributed Amplified Gate.
Design version
3. Mean on-state current, A
4. Voltage code
5. Critical rate of rise of off-state voltage
6. Group of turn-off time (dv_D/dt=50 V/μs)
7. Group of turn-on time
8. Ambient conditions: N – normal; T – tropical

NOTES

[1] Critical rate of rise of off-state voltage

Symbol of group	P2	K2	E2	A2
$(dv_D/dt)_{crit}$, V/μs	200	320	500	1000

[2]Turn-on time

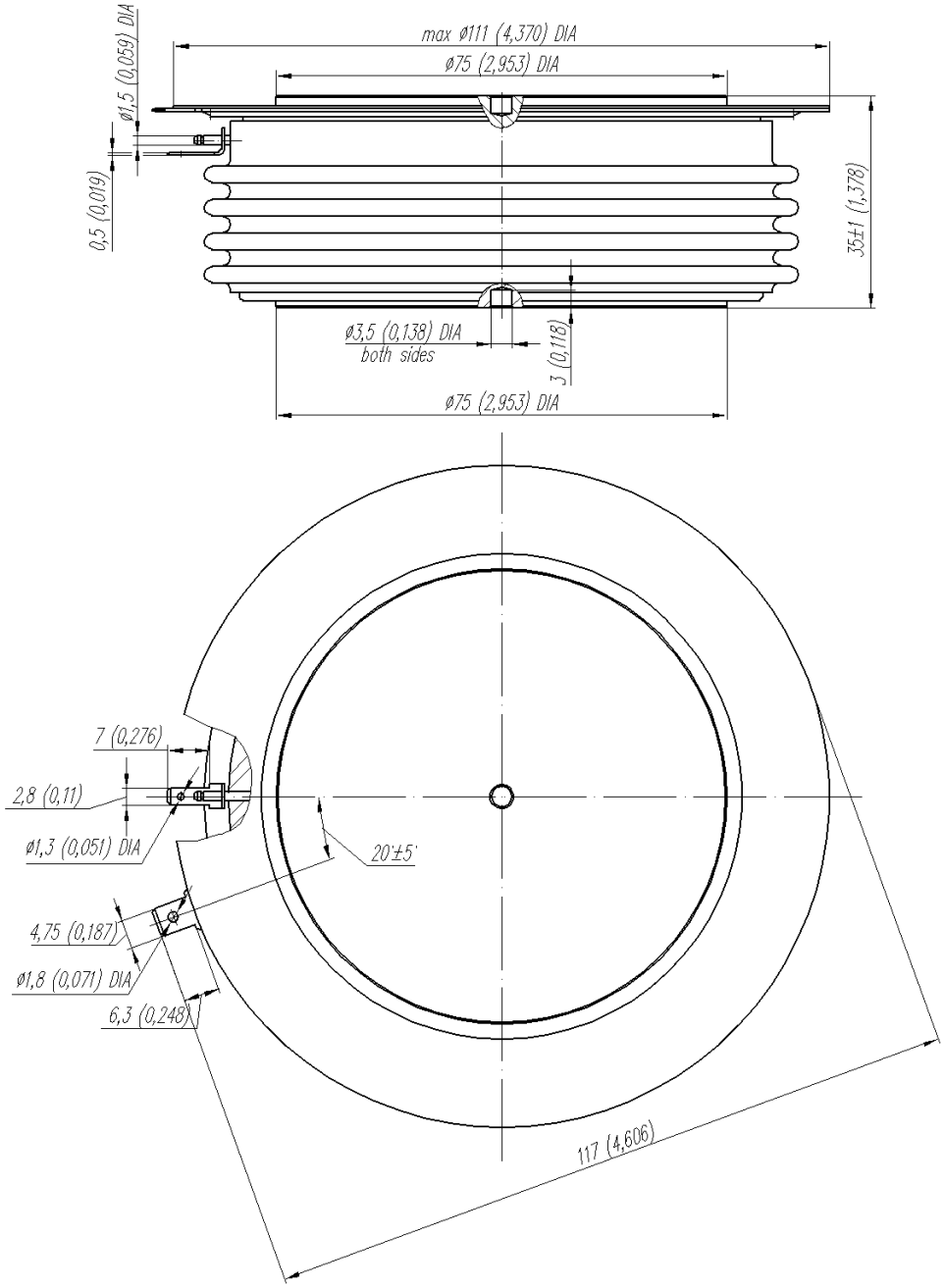
Symbol of group	M4	K4	H4	C4
t_{gt}, μs	2.50	3.20	4.00	6.30

[3]Turn-off time (dv_D/dt=50 V/μs)

Symbol of group	E3	C3
t_q, μs	50.0	63.0

OVERALL DIMENSIONS

Package type: T.F5



All dimensions in millimeters (inches)

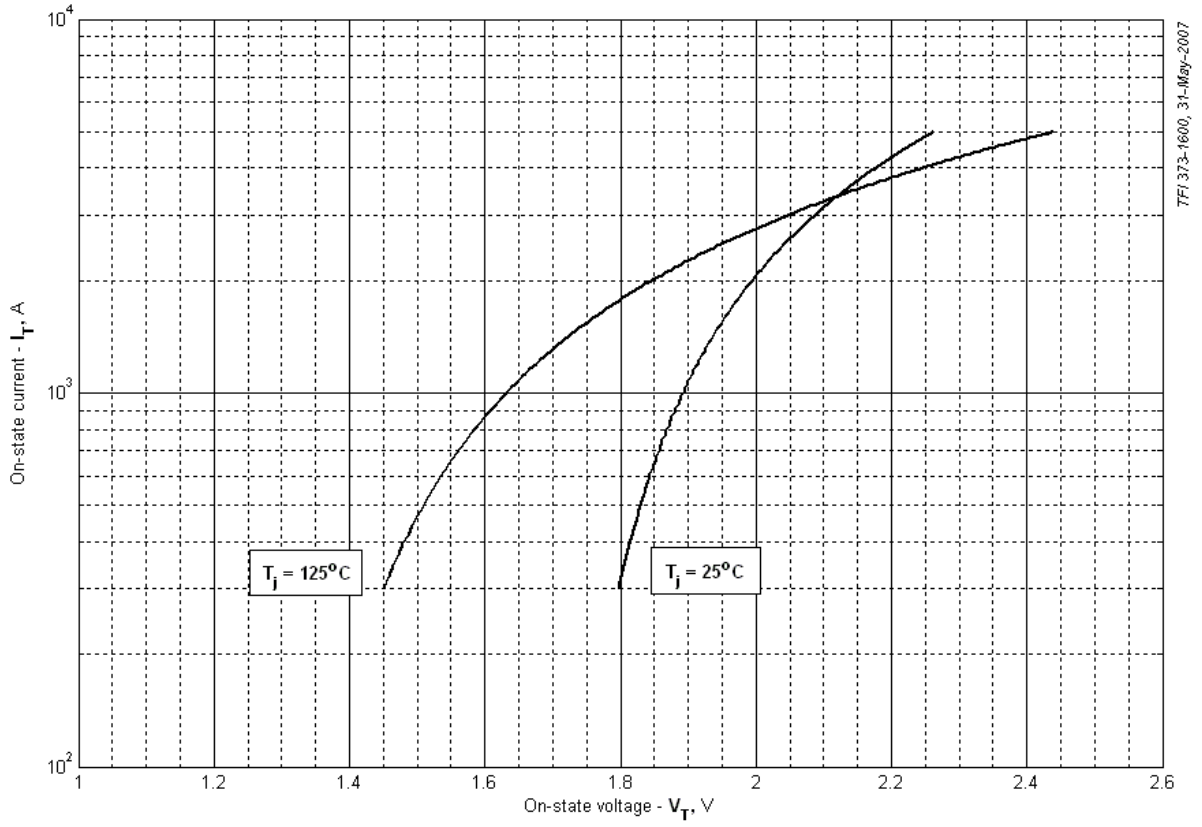


Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients	
	T_j = 25°C	$T_j = T_{j\,max}$
A	1.663692	1.248421
B	0.047151	0.141128
C	-0.169918	-0.226937
D	0.298768	0.399026

On-state characteristic model (see Fig. 1).

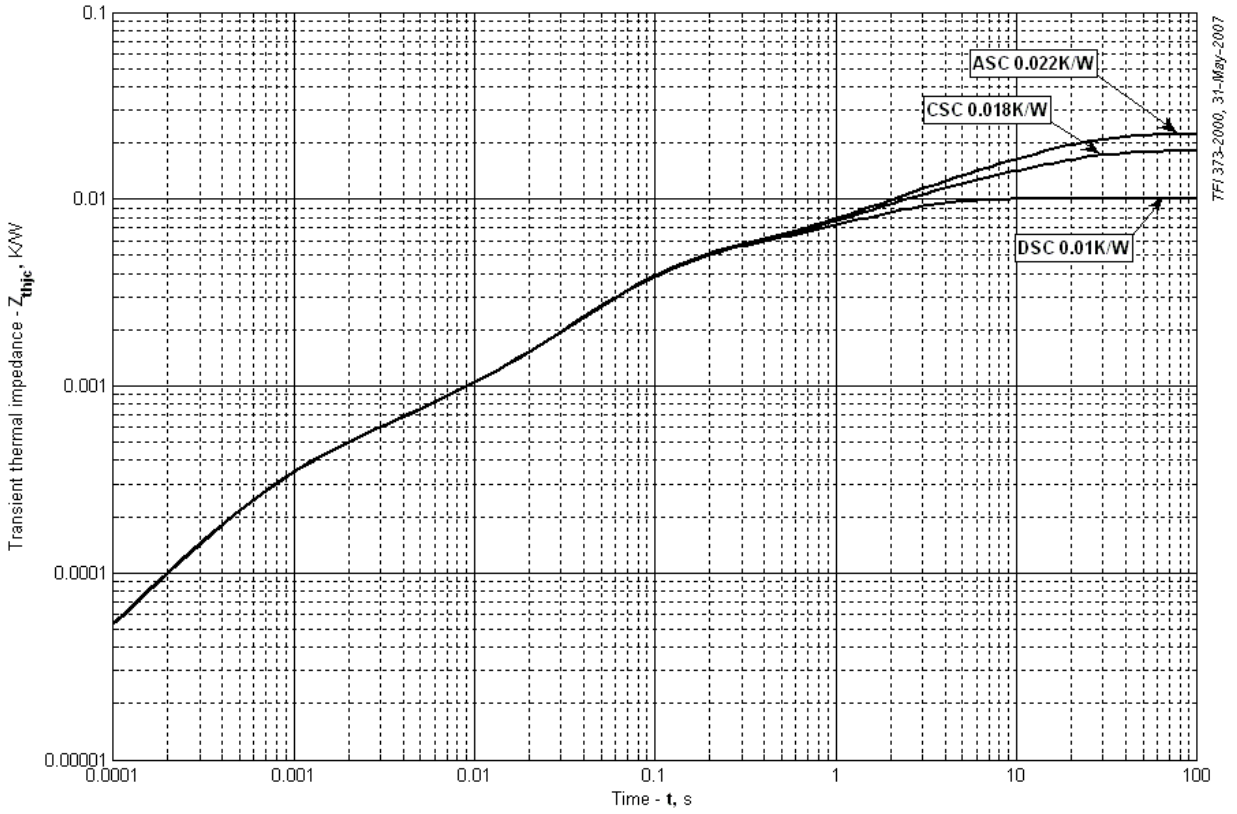


Fig 2 – Transient thermal impedance

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^{n} R_i \left(1 - e^{-\frac{t}{\tau_i}}\right)$$

Where ***i*** = 1 to ***n***, ***n*** is the number of terms in the series.

t = Duration of heating pulse in seconds.

$\mathbf{Z_{thjc}}$ = Thermal resistance at time t.

$\mathbf{R_i}$ = Amplitude of p_{th} term.

$\boldsymbol{\tau_i}$ = Time constatnt of r_{th} term.

DC Double side cooled

i	1	2	3	4	5	6
$\mathbf{R_i}$, **K/W**	0.002047	0.003474	0.0002566	0.0009157	0.0002537	0.003053
$\boldsymbol{\tau_i}$, **s**	2.208	0.07263	0.002379	0.1468	0.0006251	1.336

DC Anode side cooled

i	1	2	3	4	5	6
$\mathbf{R_i}$, **K/W**	0.01236	0.004677	0.0005872	0.004097	0.0002182	0.000307
$\boldsymbol{\tau_i}$, **s**	13.330	2.000	0.4303	0.07916	0.003128	0.0007049

DC Cathode side cooled

i	1	2	3	4	5	6
$\mathbf{R_i}$, **K/W**	0.008162	0.004629	0.000628	0.004107	0.0002172	0.0003086
$\boldsymbol{\tau_i}$, **s**	13.290	1.911	0.4529	0.0791	0.003157	0.0007072

Transient thermal impedance junction to case $\mathbf{Z_{thjc}}$ model (see Fig. 2).

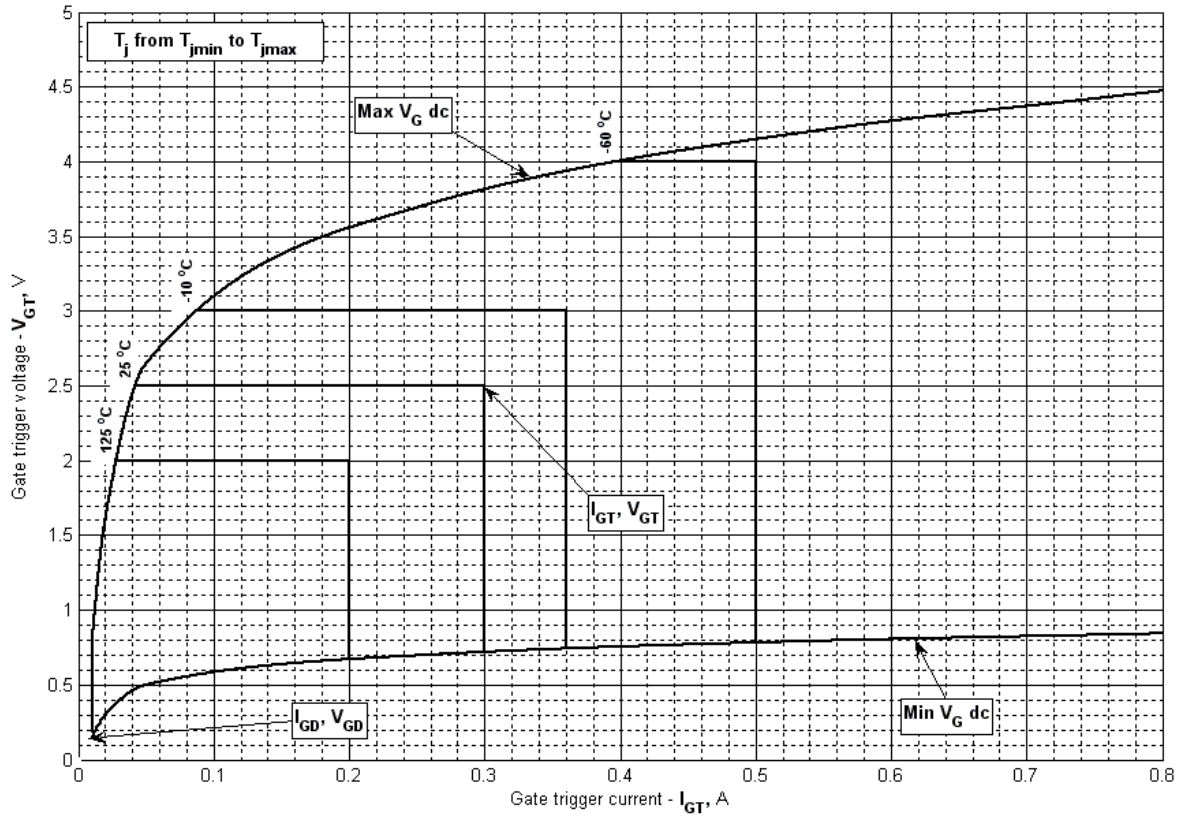


Fig 3 – Gate characteristics – Trigger limits

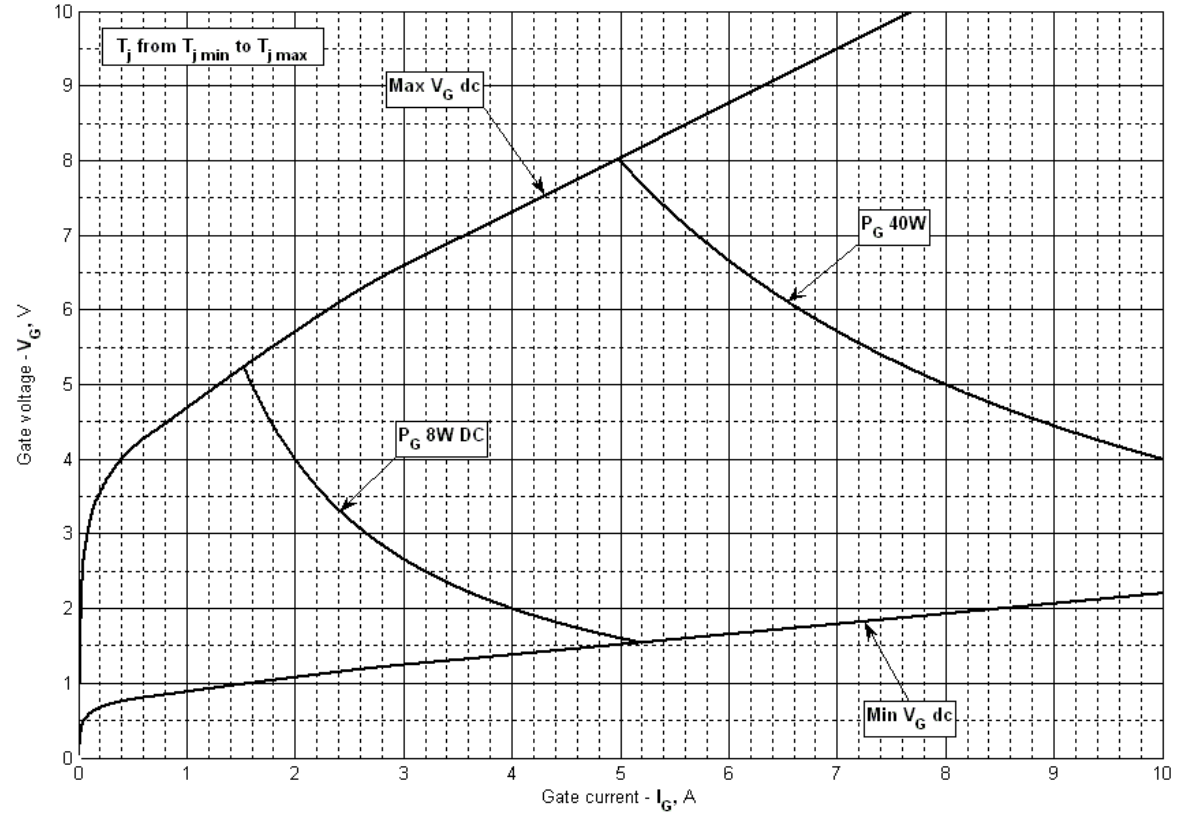


Fig 4 - Gate characteristics –Power curves

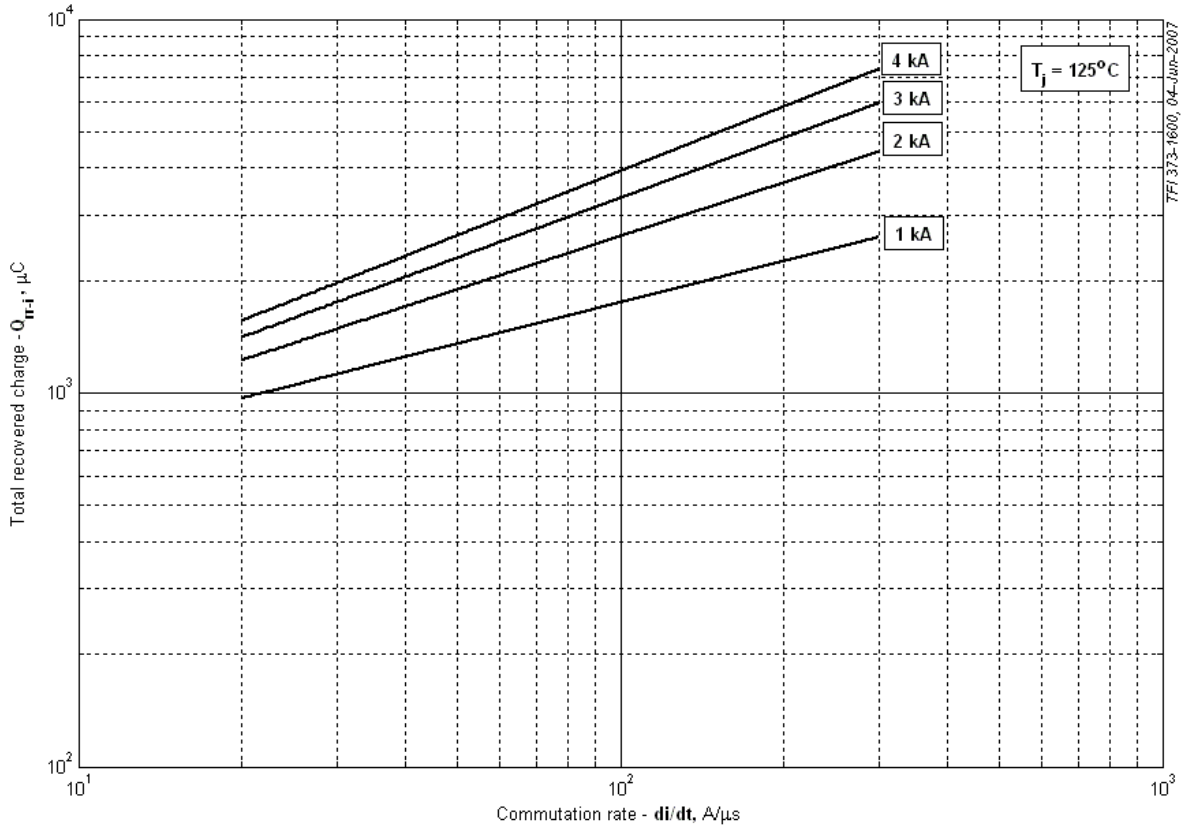


Fig 5 – Total recovered charge, Q_{rr-i} (integral)

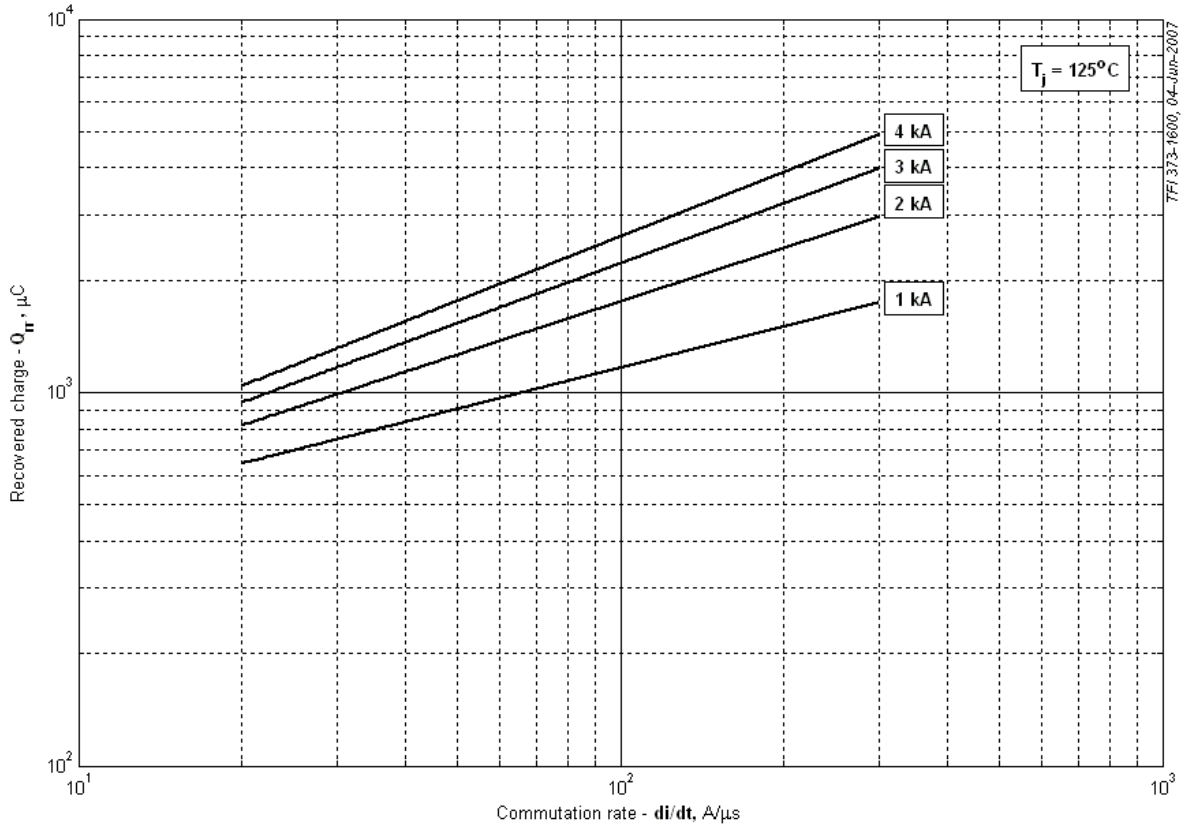


Fig 6 - Recovered charge, Q_{rr} (25% chord)

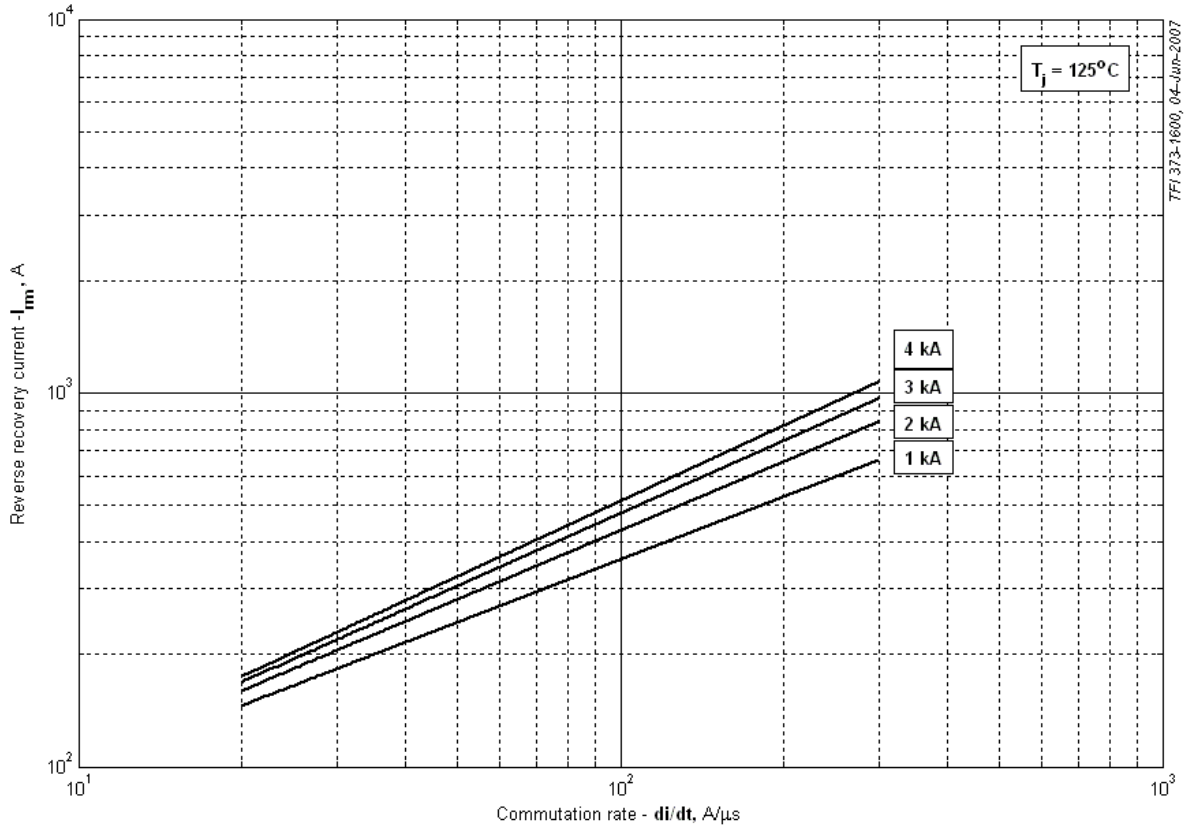


Fig 7 – Peak reverse recovery current, I_{rm}

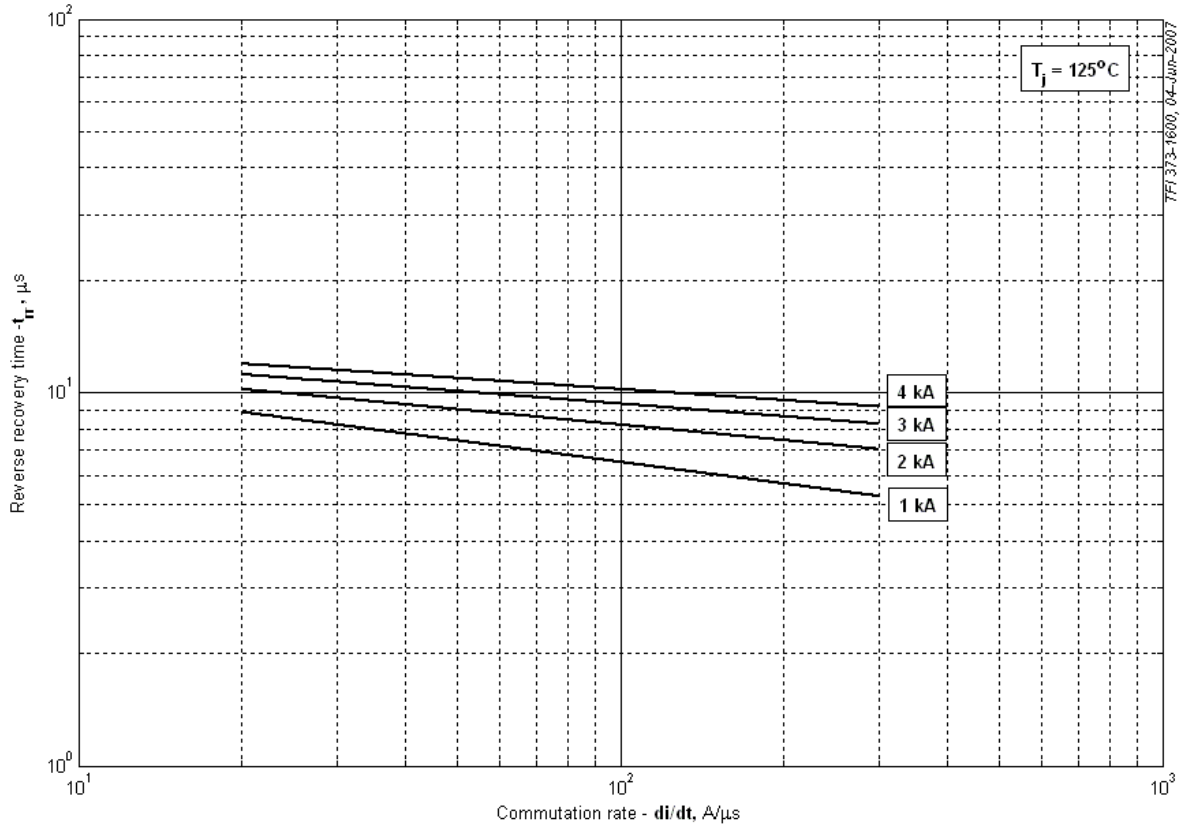


Fig 8 – Maximum recovery time, t_{rr} (25% chord)

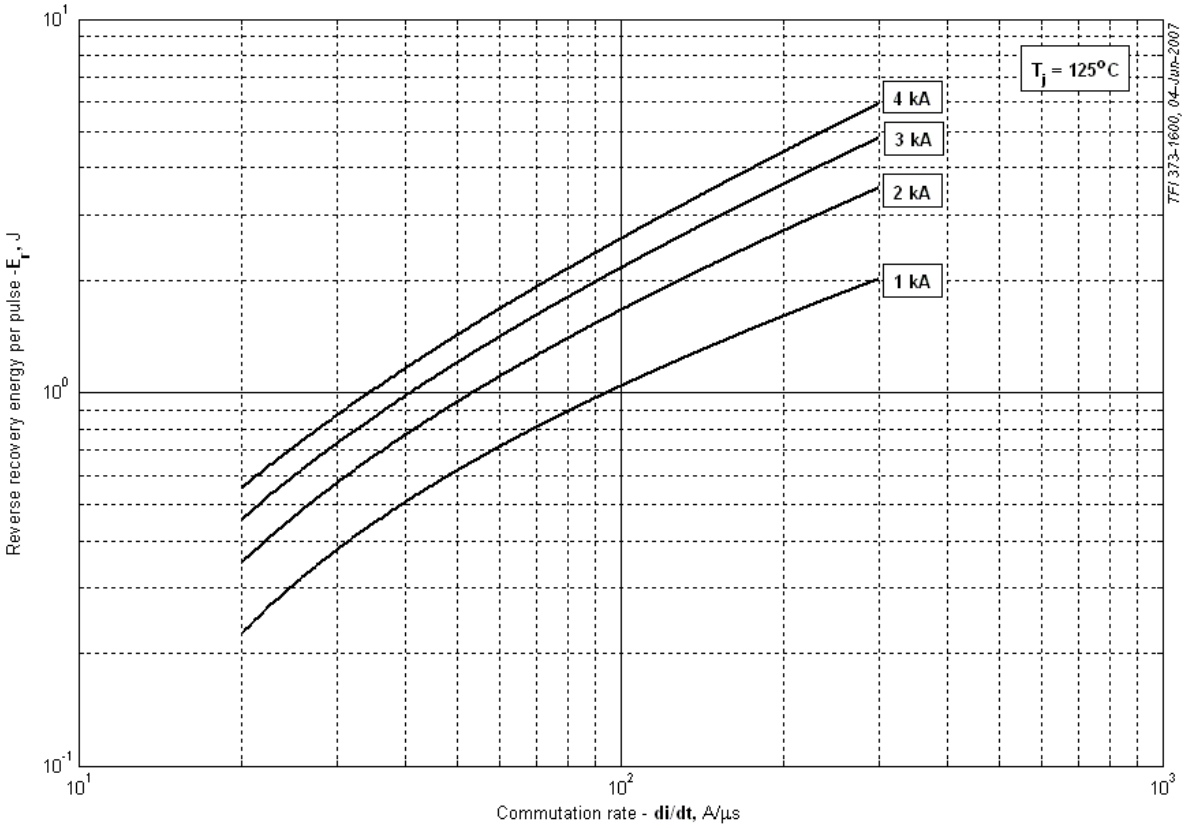


Fig 9 – Reverse recovery energy per pulse

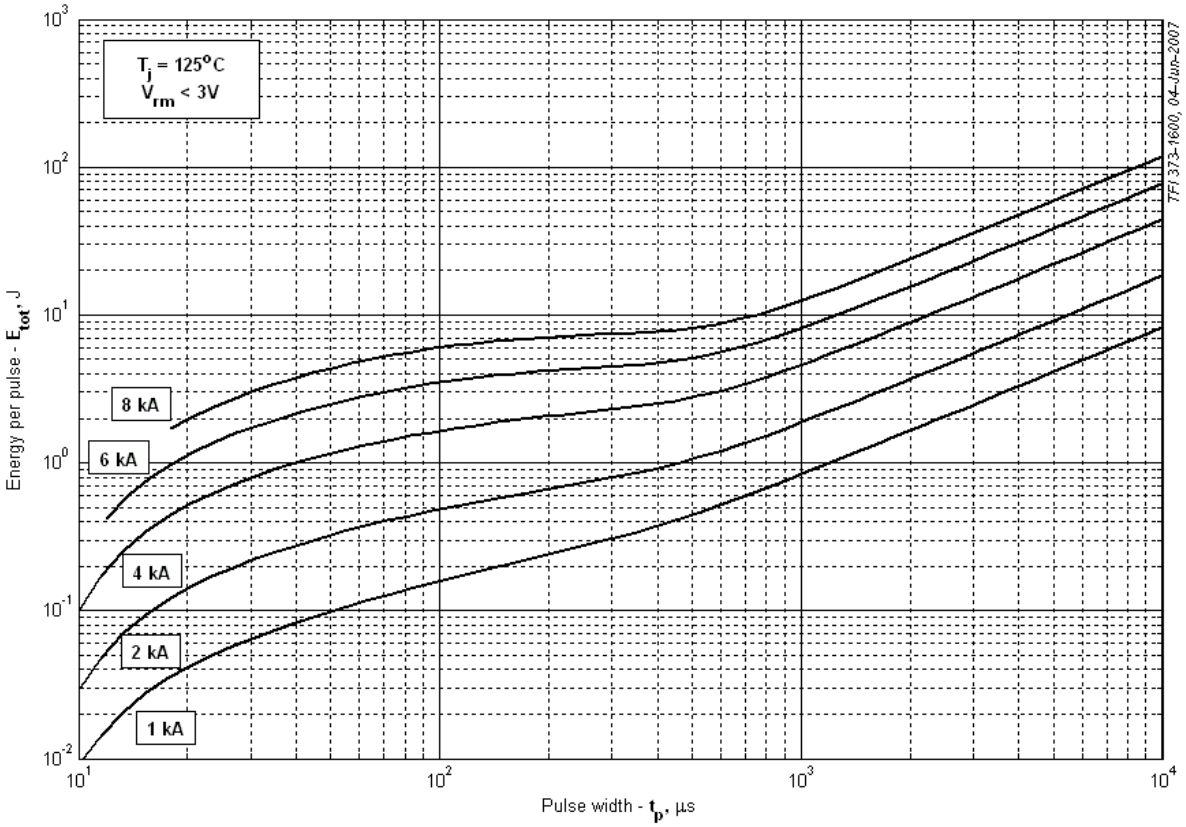


Fig 10 – Sine wave energy per pulse

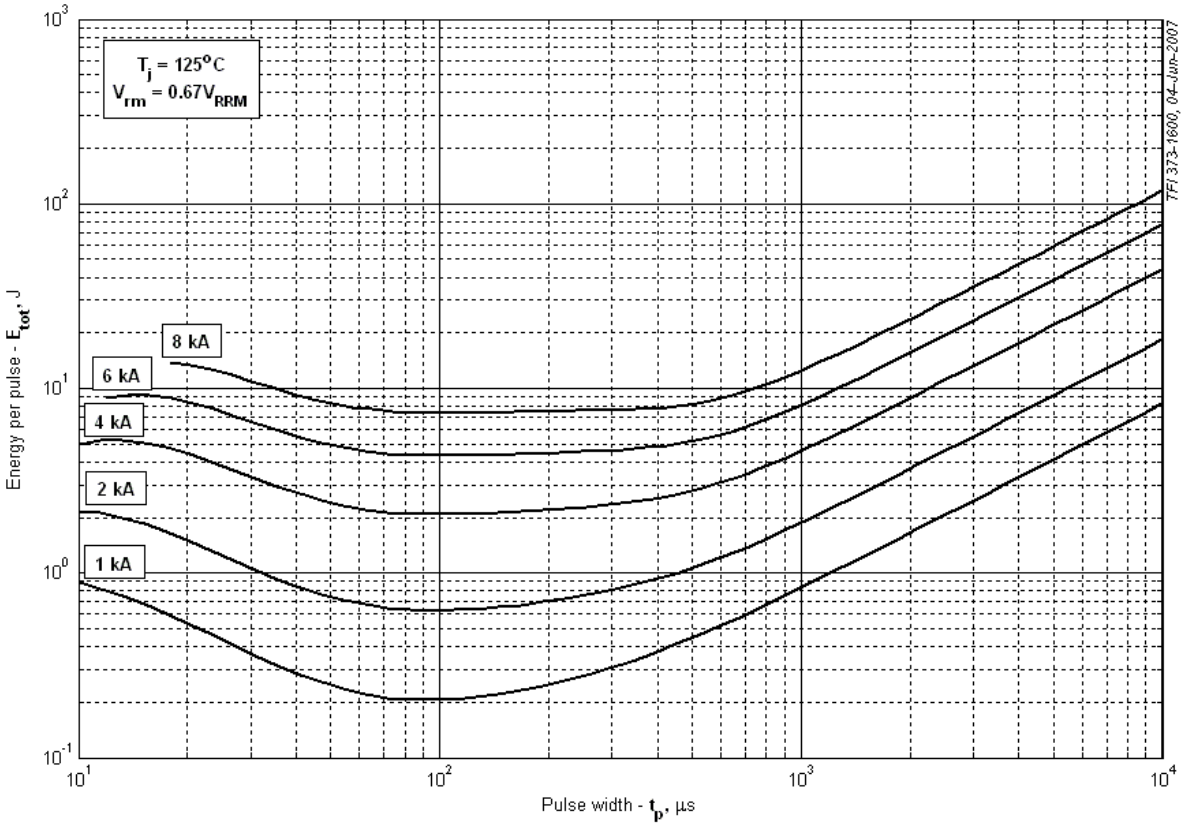


Fig 11 – Sine wave energy per pulse

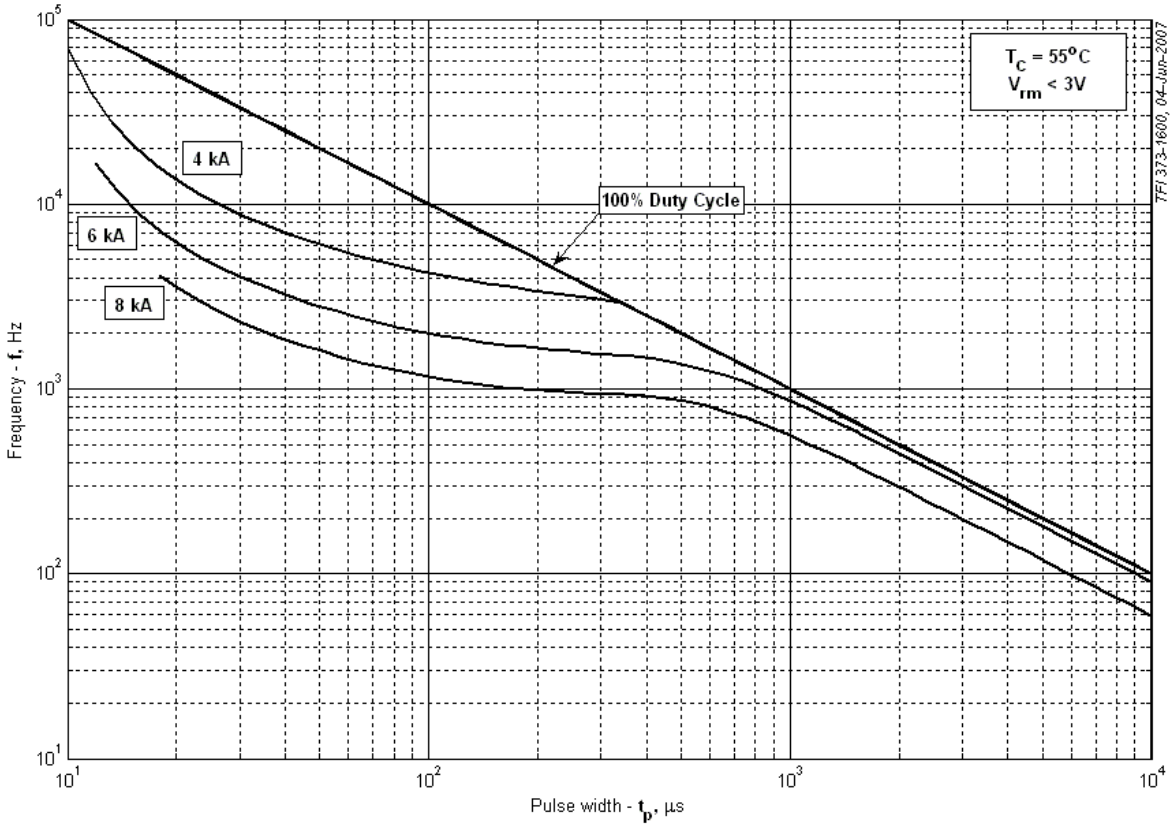


Fig 12 – Sine wave frequency ratings

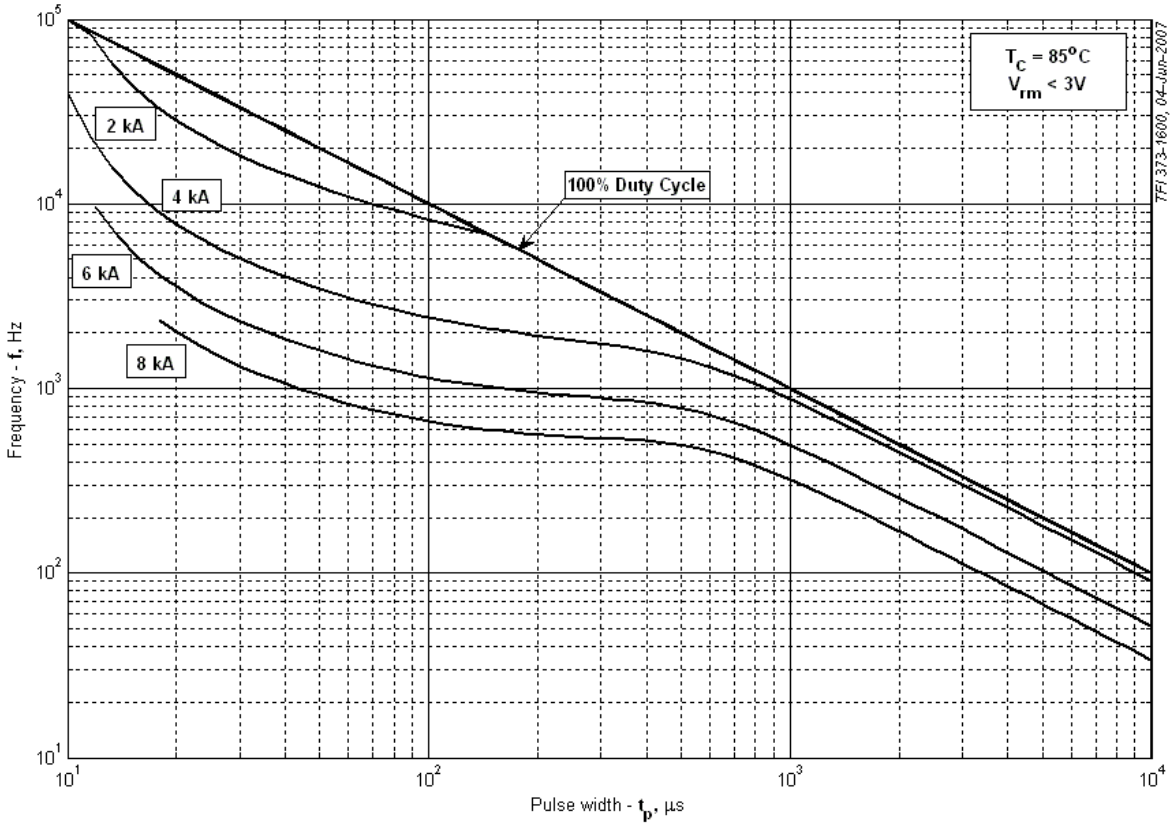


Fig 13 – Sine wave frequency ratings

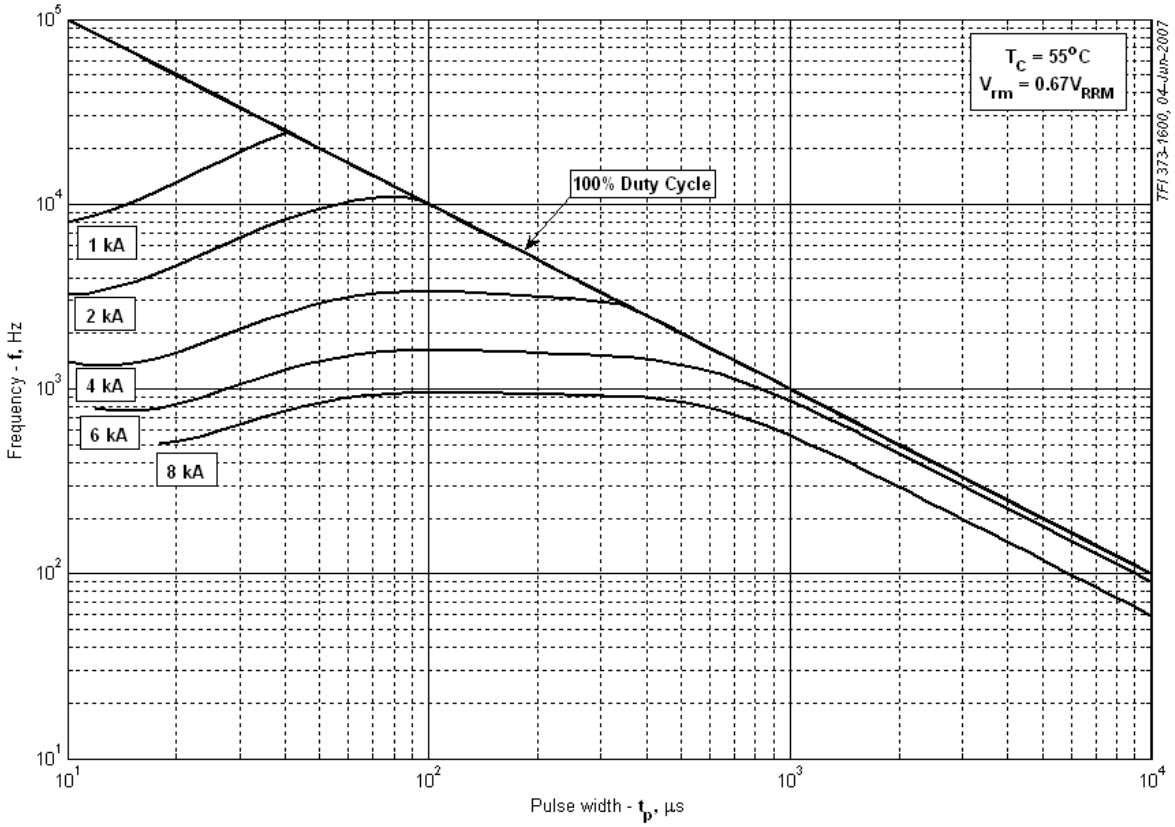


Fig 14 – Sine wave frequency ratings

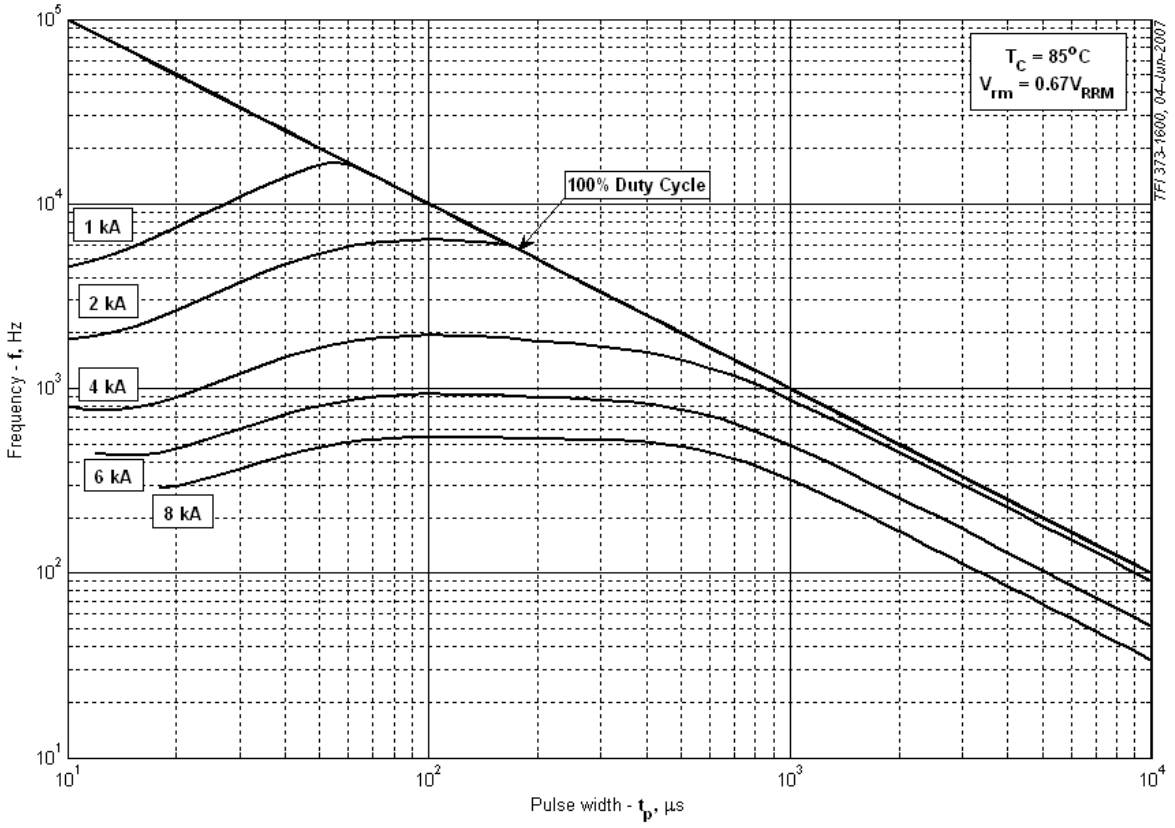


Fig 15 – Sine wave frequency ratings

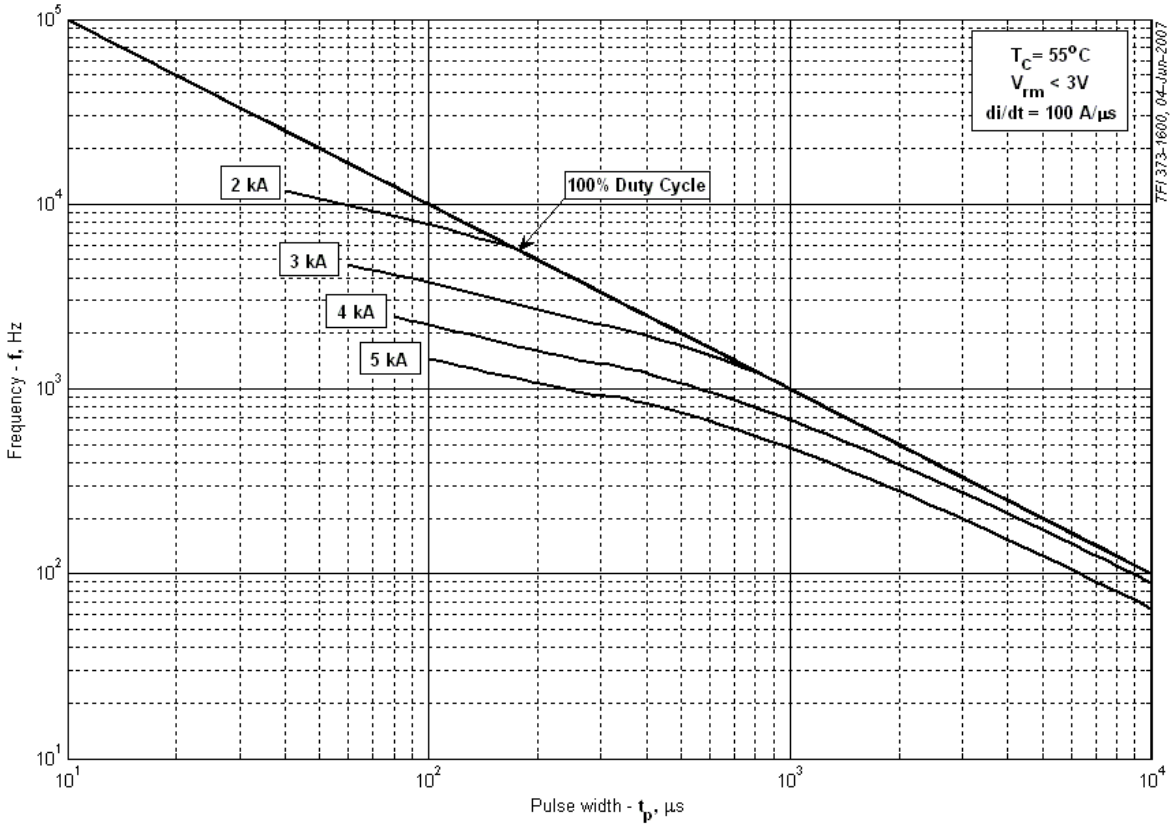


Fig 16 – Square wave frequency ratings

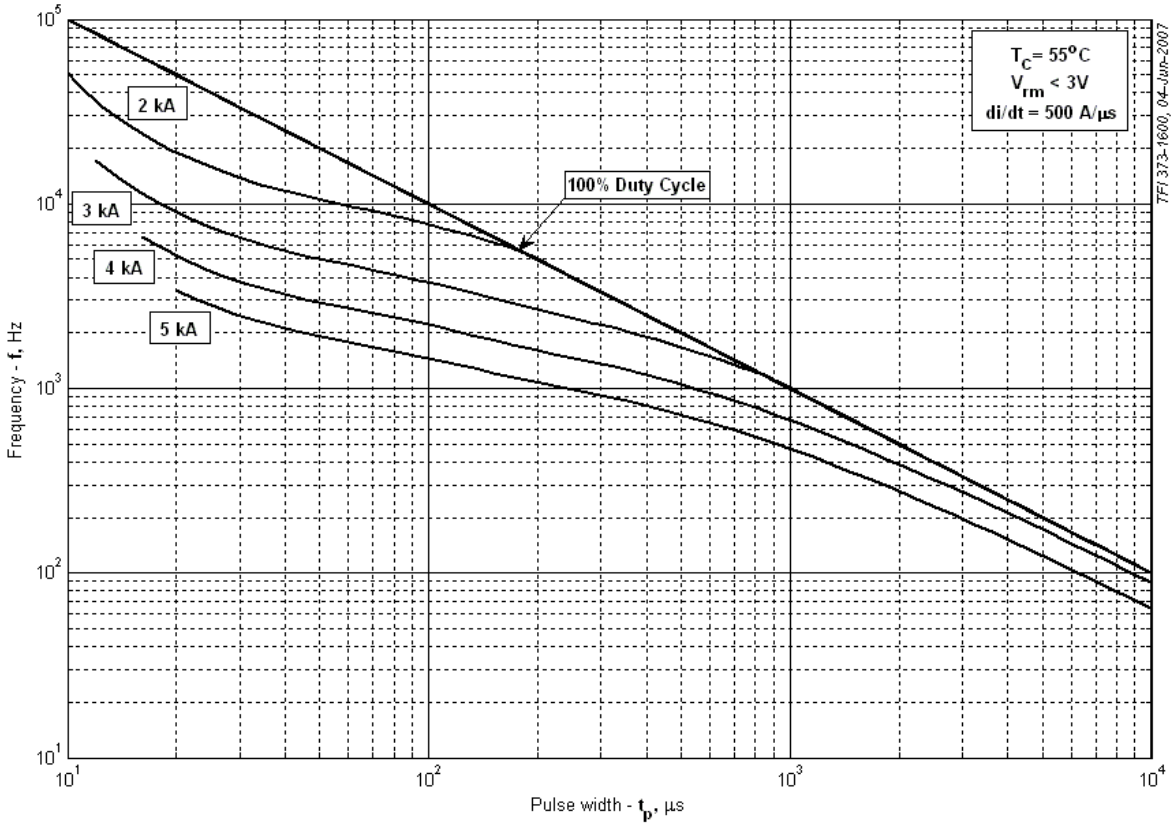


Fig 17 – Square wave frequency ratings

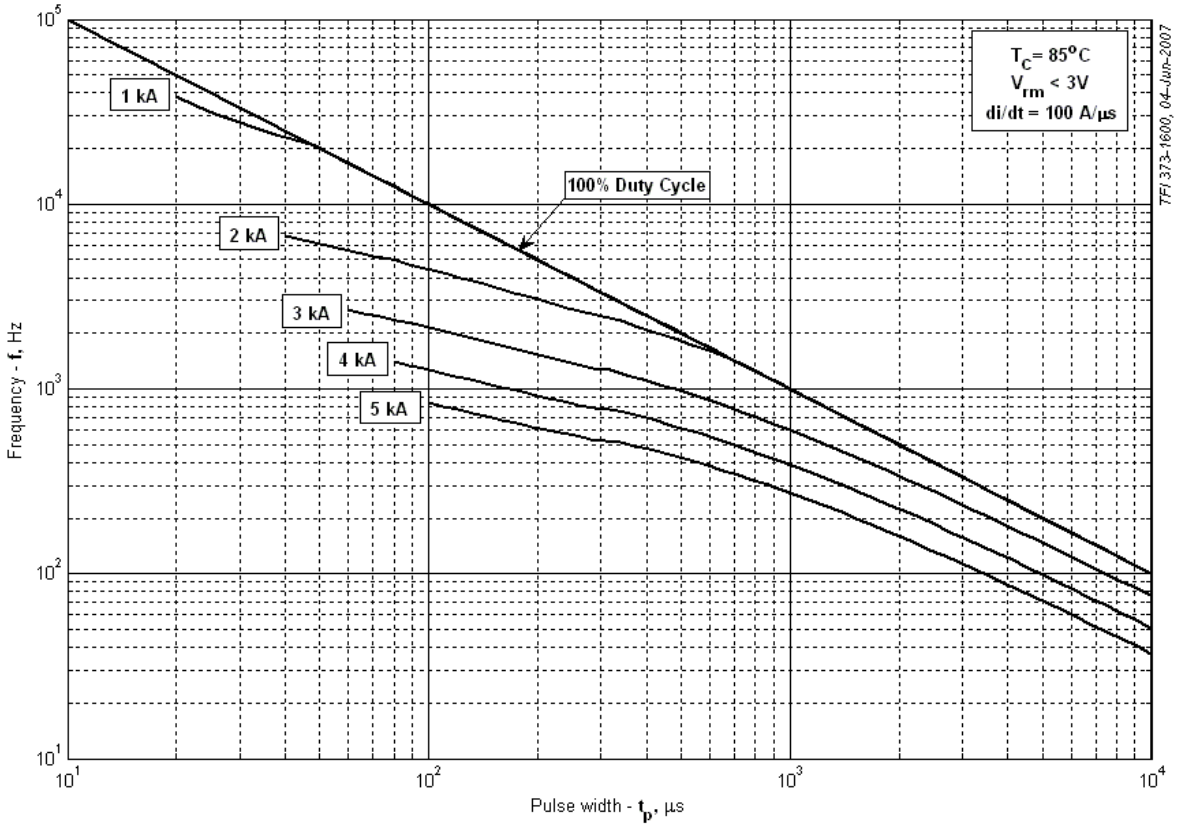


Fig 18 – Square wave frequency ratings

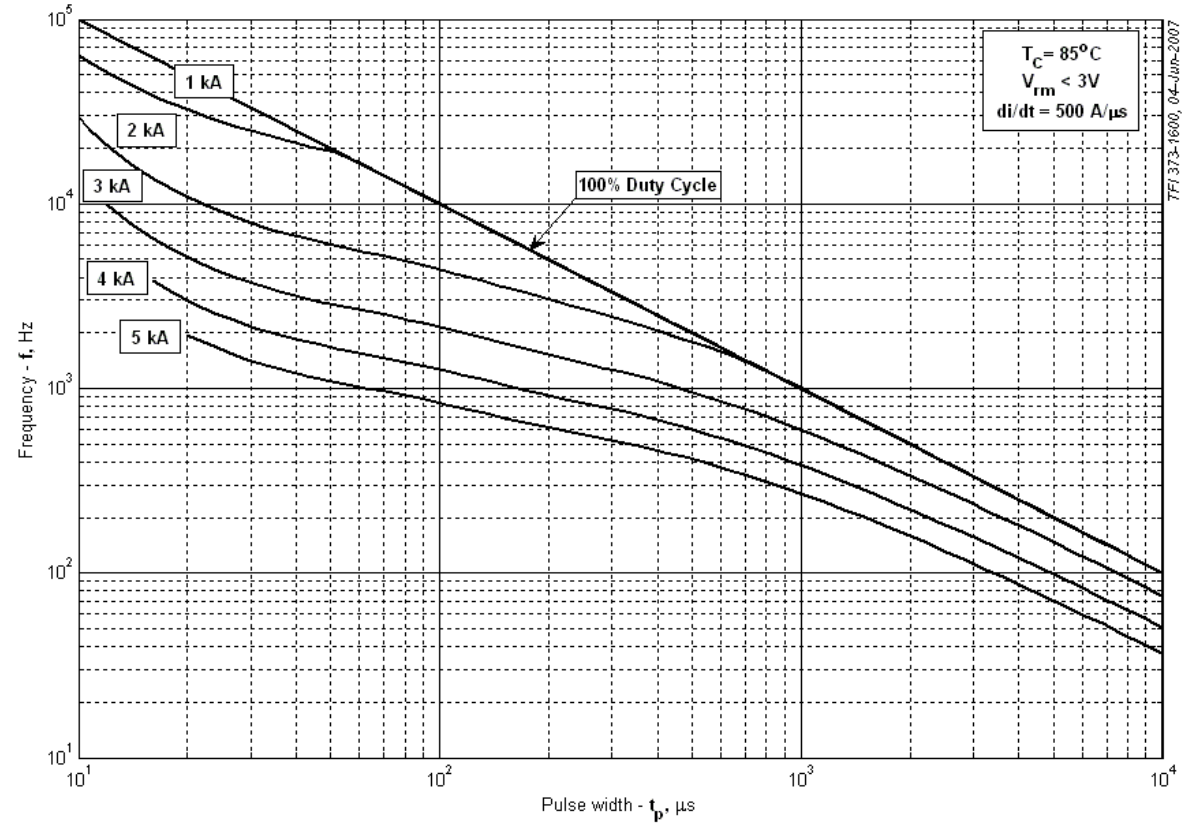


Fig 19 – Square wave frequency ratings

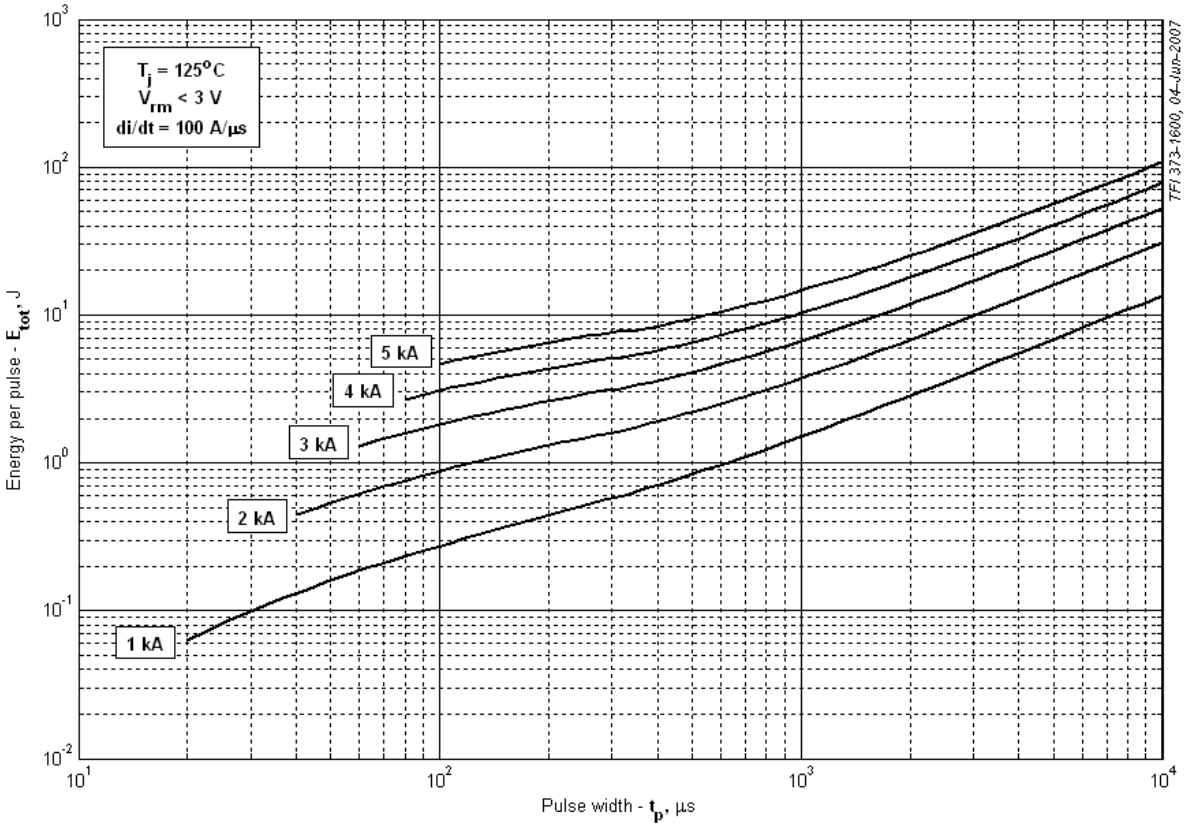


Fig 20 – Square wave energy per pulse

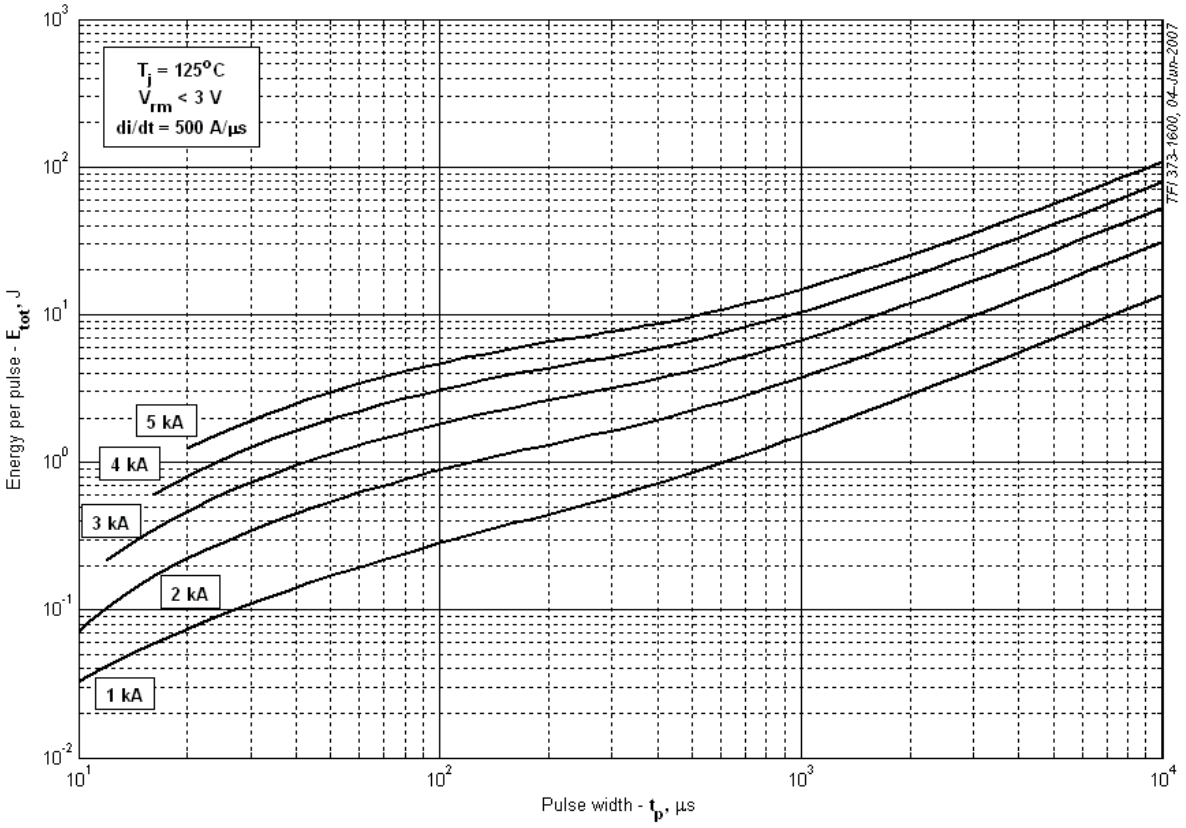


Fig 21 – Square wave energy per pulse

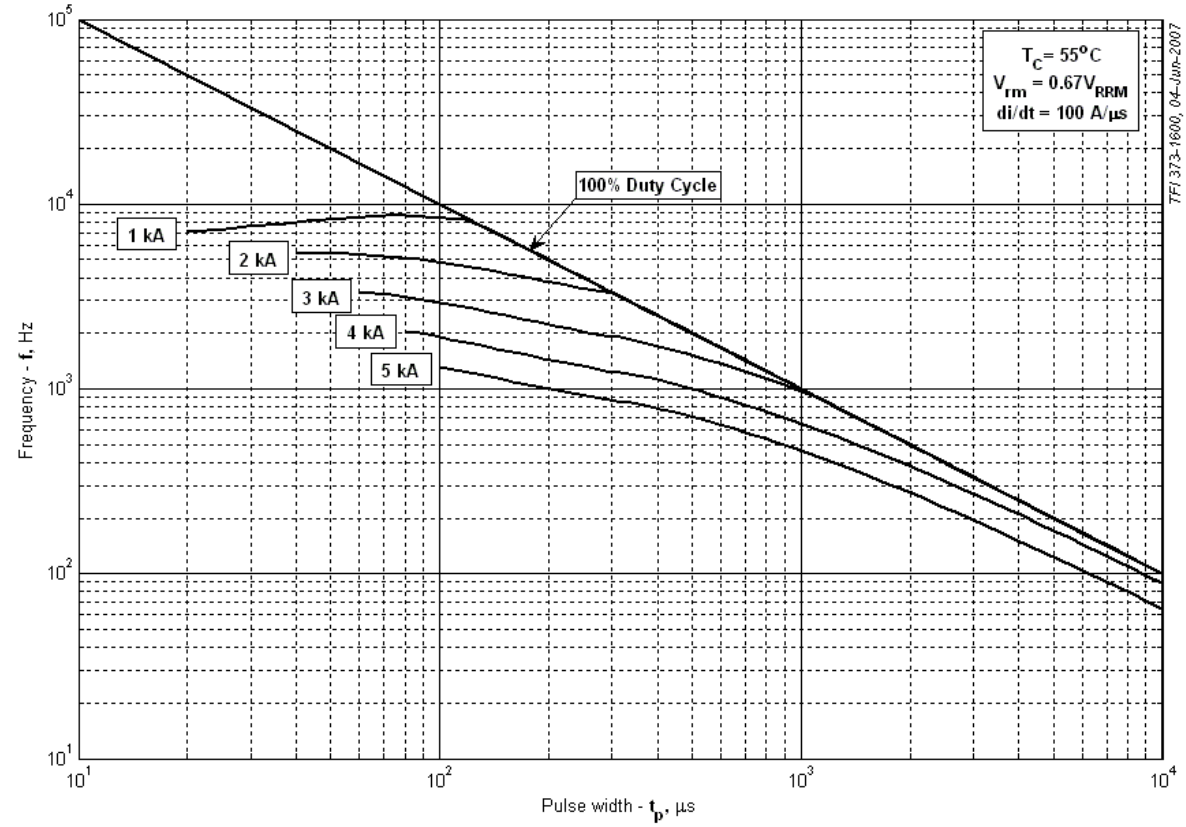


Fig 22 – Square wave frequency ratings

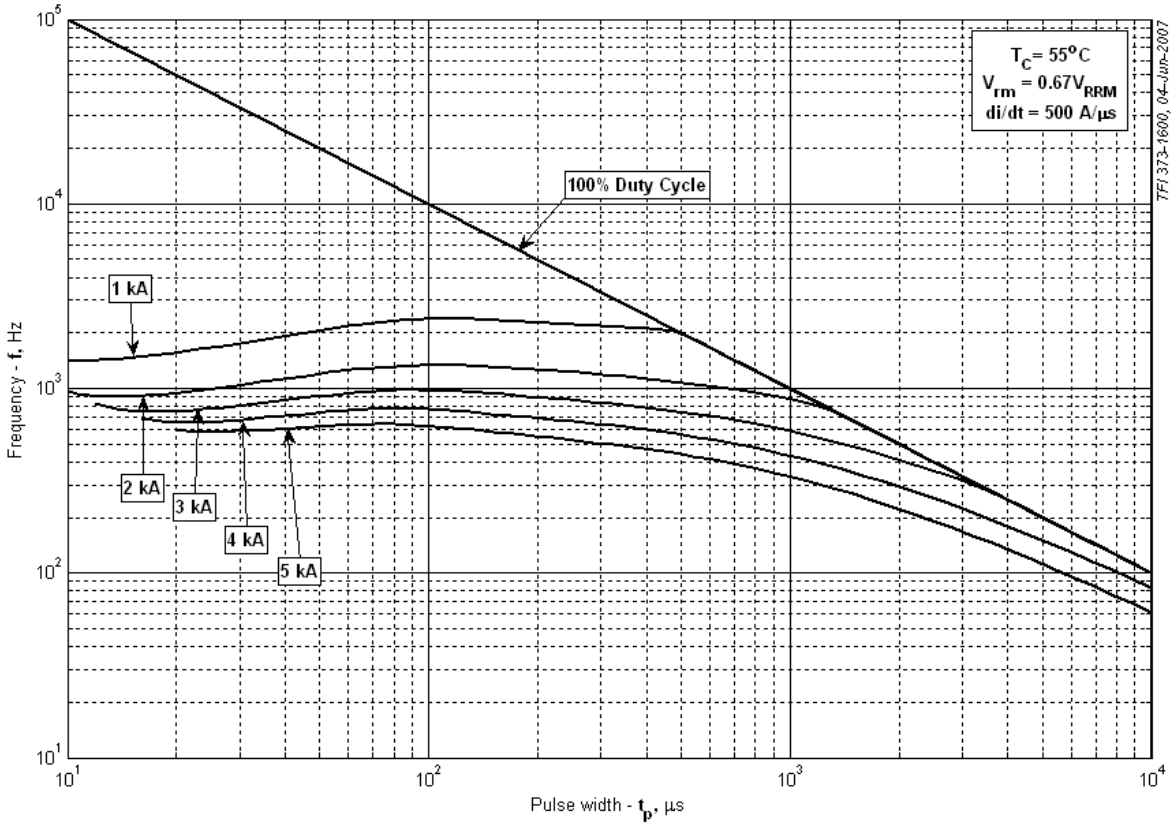


Fig 23 – Square wave frequency ratings

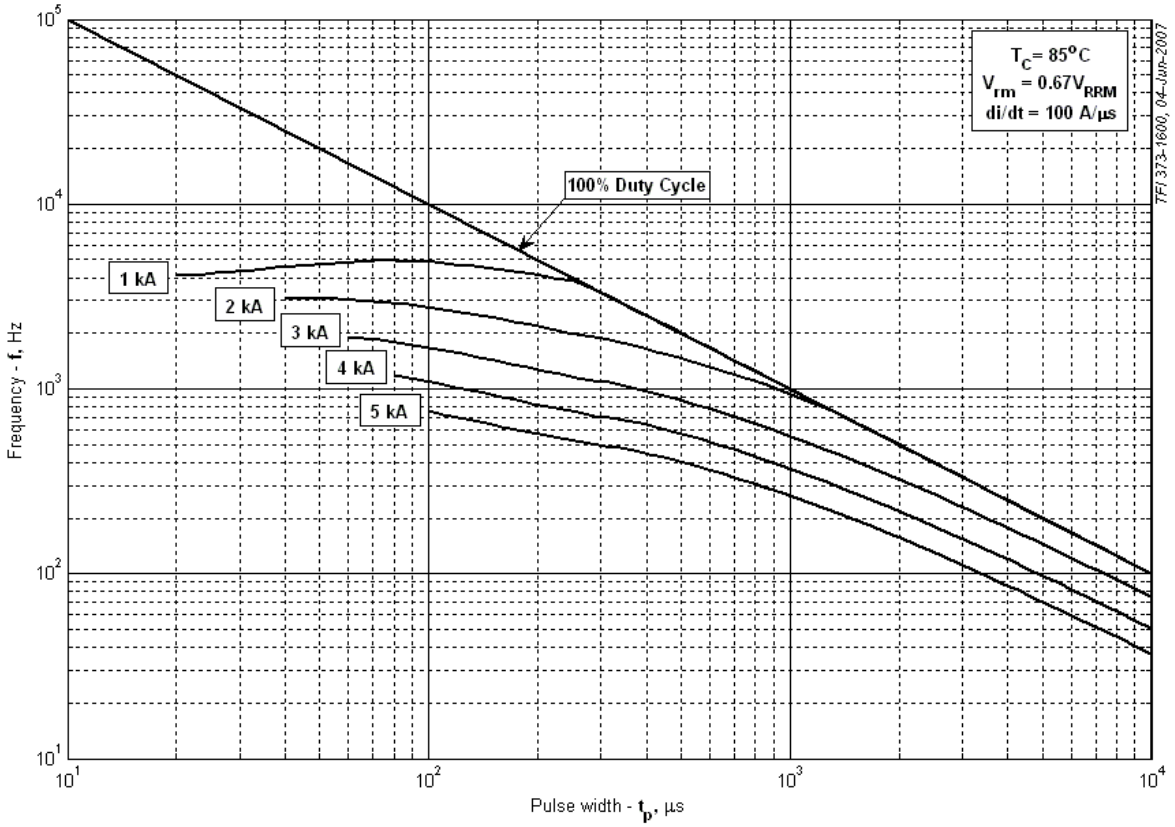


Fig 24 – Square wave frequency ratings

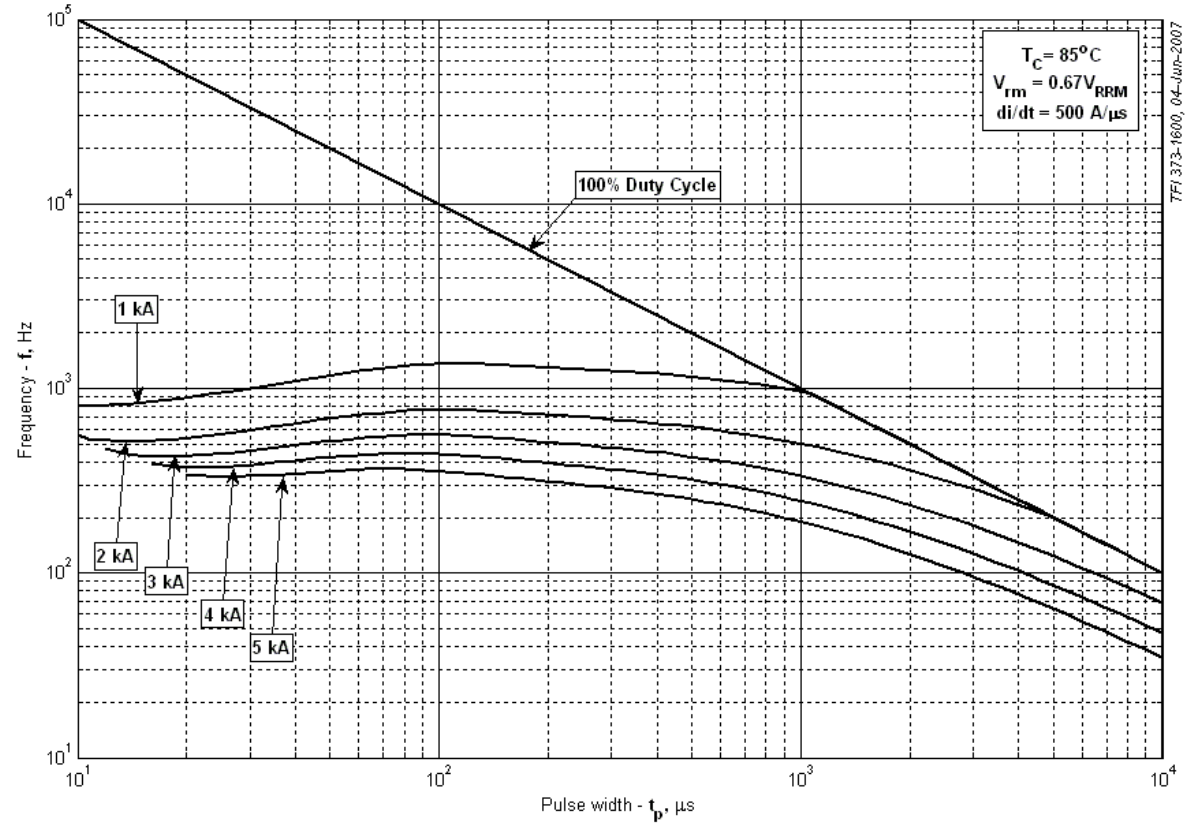


Fig 25 – Square wave frequency ratings

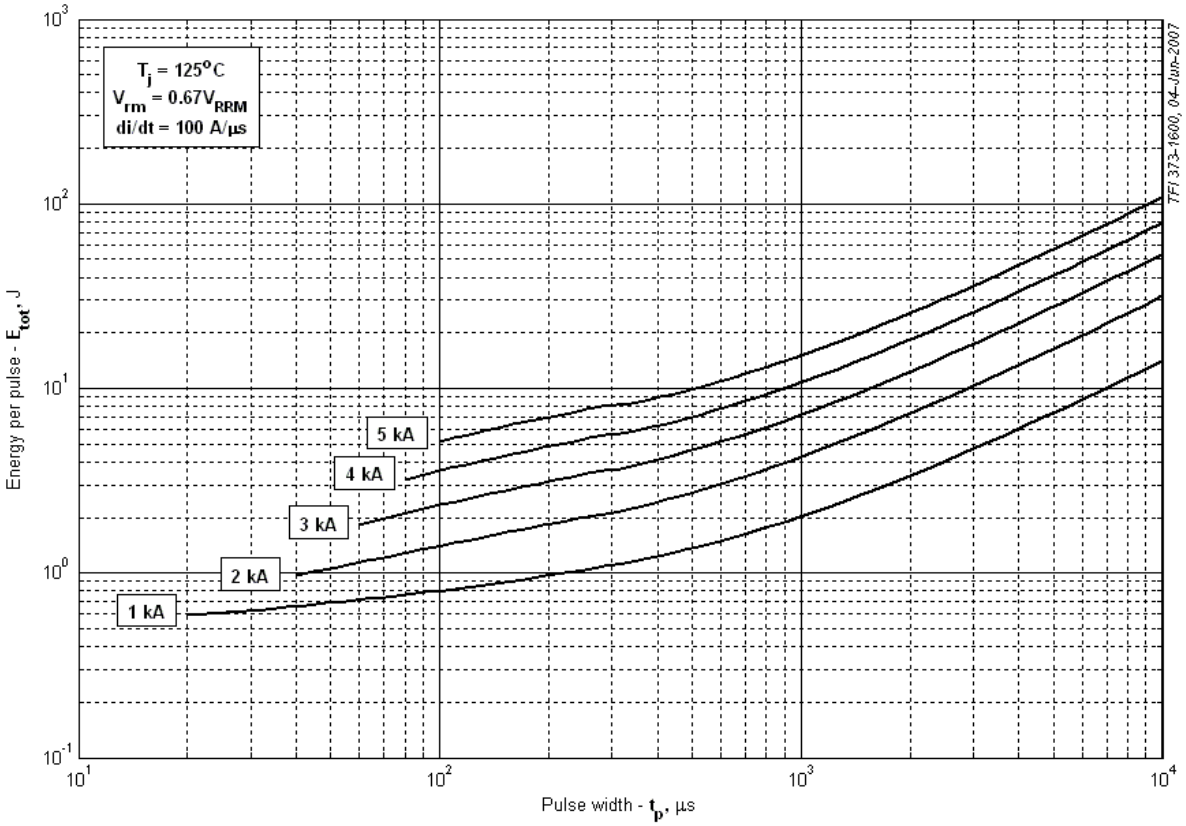


Fig 26 – Square wave energy per pulse

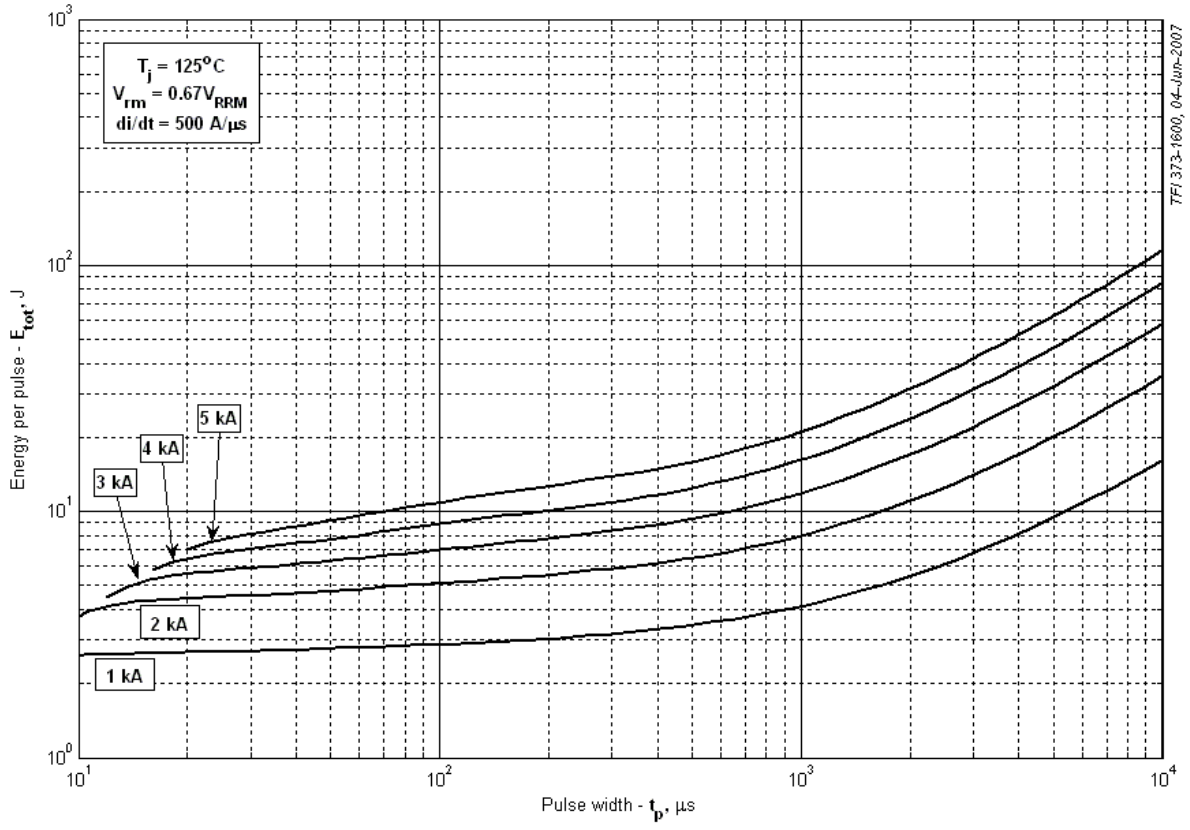


Fig 27 – Square wave energy per pulse

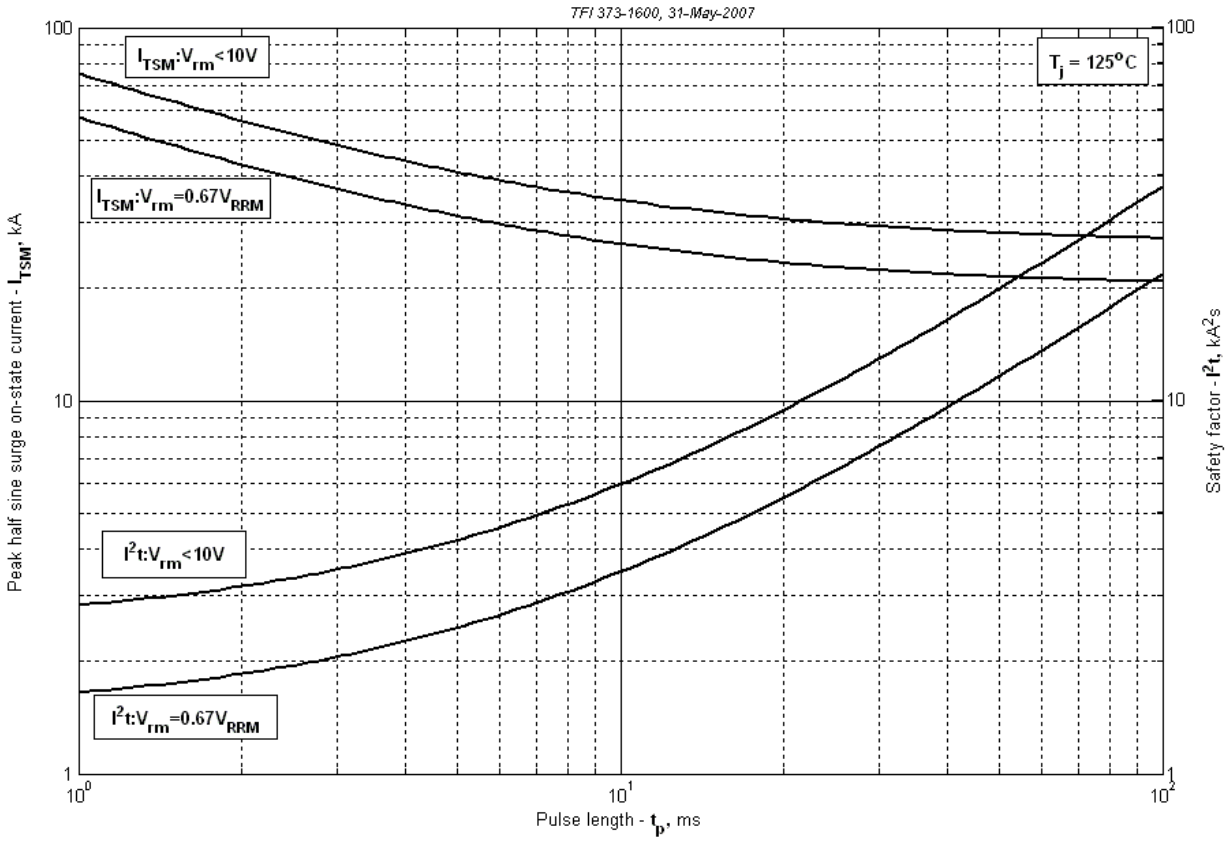


Fig 28 – Maximum surge and I^2t ratings

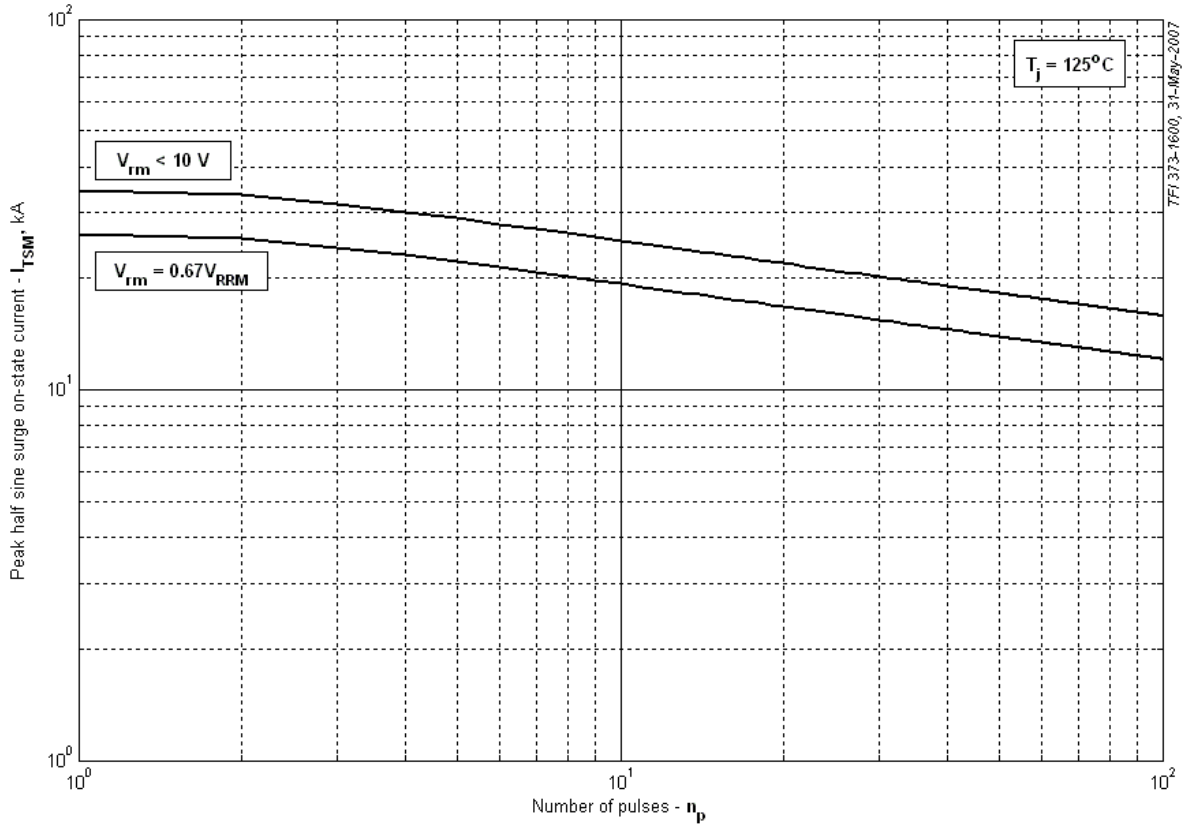


Fig 29 – Maximum surge ratings